

# Specification

## SSC-SZ5-P series

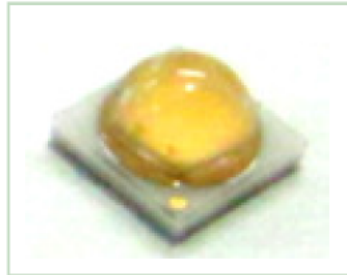
## SZ5-P series

### Description

The Z-Power series is designed for high current operation and high flux output applications.

It incorporates state of the art SMD design and low thermal resistant material.

The Z Power LED is ideal light sources for general illumination applications, custom designed solutions, large backlights and high performance torches.



## SZ5-P

### Features

- Super high Flux output and high Luminance
- Designed for high current operation
- SMT solderable
- Lead Free product
- RoHS compliant

### Applications

- General Torch
- Architectural lighting
- Projector light source
- Traffic signals
- Task lighting
- Decorative / Pathway lighting
- Remote / Solar powered lighting

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## 1. Full code of SZ5-P series

Full code form :  $X_1 X_2 X_3 - X_4 X_5 - X_6 X_7 - X_8 X_9$

### 1. Part Number

|       |         |
|-------|---------|
| $X_1$ | Company |
|-------|---------|

|       |                           |
|-------|---------------------------|
| $X_2$ | Z-Power LED series number |
|-------|---------------------------|

|       |            |
|-------|------------|
| $X_3$ | PKG series |
|-------|------------|

### 2. Internal Number

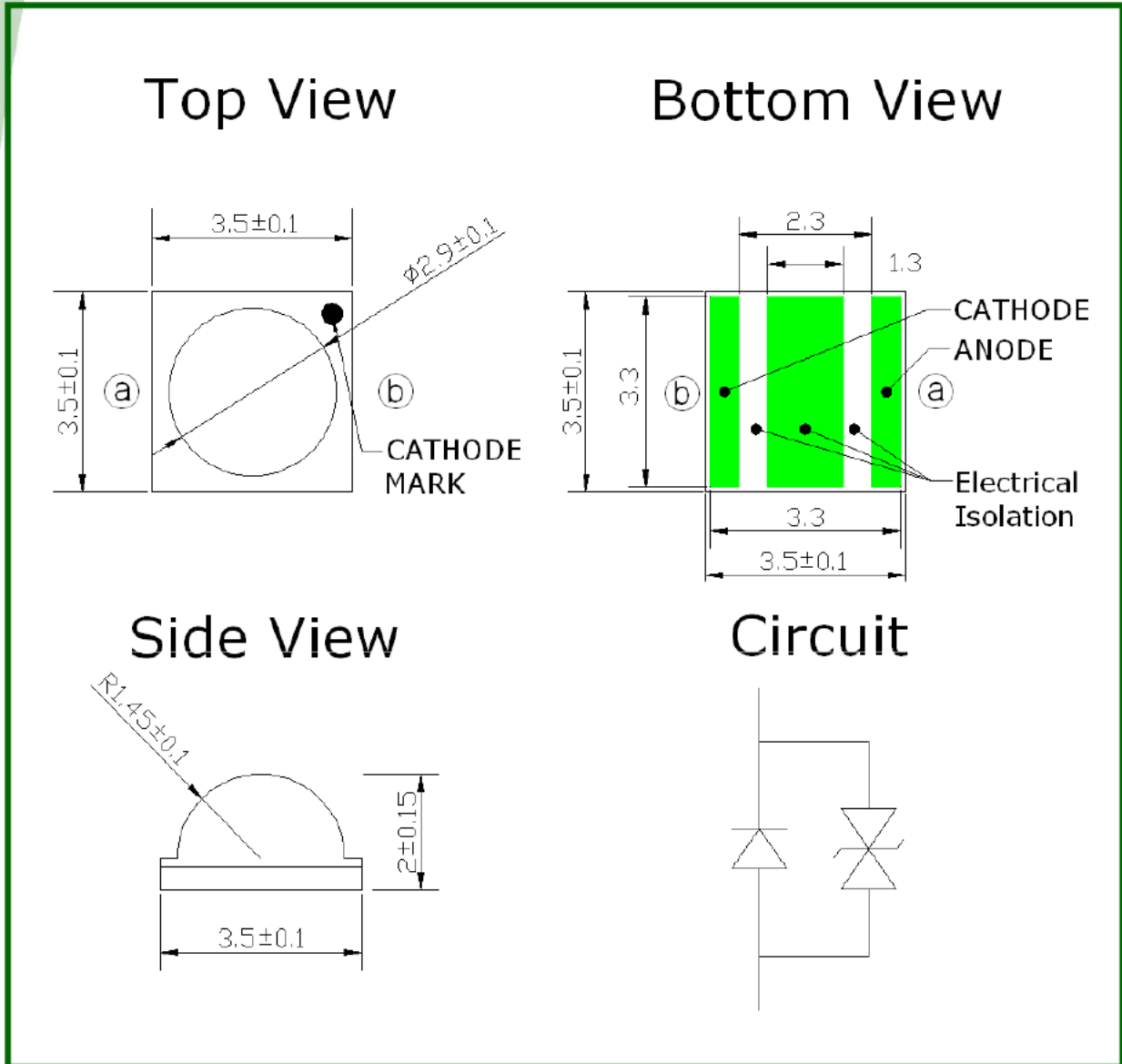
|       |          |
|-------|----------|
| $X_4$ | PCB Type |
| P     | P series |

|       |                 |
|-------|-----------------|
| $X_5$ | Revision number |
|-------|-----------------|

|           |                     |
|-----------|---------------------|
| $X_6 X_7$ | Color Specification |
| W0        | Pure white          |
| WN        | Neutral white       |
| WW        | Warm white          |

|           |                     |
|-----------|---------------------|
| $X_8 X_9$ | Color Specification |
| C8        | CRI min 80          |
| 85        | CRI min 85          |
| 00        | The others          |

## 2. Outline dimensions



Notes :

- [1] All dimensions are in millimeters.
- [2] Scale : none
- [3] Undefined tolerance is  $\pm 0.1$ mm

### 3. Characteristics of SZ5-P0-WN-C8(Neutral) Neutral White

#### 1-1 Electro-Optical characteristics at 350mA

(Ta=25°C, RH30%)

| Parameter                        | Symbol              | Value |       |     | Unit |
|----------------------------------|---------------------|-------|-------|-----|------|
|                                  |                     | Min   | Typ   | Max |      |
| Luminous Flux [1]                | $\Phi_V$ [2]        | -     | 118.5 | -   | lm   |
|                                  | $\Phi_V$ (Tj=100°C) | -     | 105   | -   |      |
| Correlated Color Temperature [3] | CCT                 | -     | 4200  | -   | K    |
| CRI [6]                          | R <sub>a</sub>      | 80    | -     | -   | -    |
| Forward Voltage [4]              | V <sub>F</sub>      | -     | 3.20  | -   | V    |
| Thermal resistance (J to S)      | R $\theta_{J-S}$    |       | 5.5   |     | K/W  |
| View Angle                       | 2 $\theta$ 1/2      |       | 120   |     | deg. |

#### 1-2 Absolute Maximum Ratings

| Parameter                | Symbol           | Value                          | Unit |
|--------------------------|------------------|--------------------------------|------|
| Forward Current          | I <sub>F</sub>   | 1000                           | mA   |
|                          |                  | 1800 (100ms, 1/10duty)         |      |
| Reverse Voltage          | V <sub>r</sub>   | 5                              | V    |
| Power Dissipation        | P <sub>d</sub>   | 4.1                            | W    |
| Junction Temperature     | T <sub>j</sub>   | 145(@ I <sub>F</sub> ≤ 1000mA) | °C   |
| Operating Temperature    | T <sub>opr</sub> | -40 ~ +85                      | °C   |
| Storage Temperature      | T <sub>stg</sub> | -40 ~ +100                     | °C   |
| ESD Sensitivity(HBM) [5] | -                | 2                              | kV   |

\*Notes :

[1] SSC maintains a tolerance of ±7% on flux and power measurements.

[2]  $\Phi_V$  is the total luminous flux output as measured with an integrating sphere.

[3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.

Color coordinate : ±0.005, CCT ±5% tolerance.

[4] Tolerance is ±0.06V on forward voltage measurements

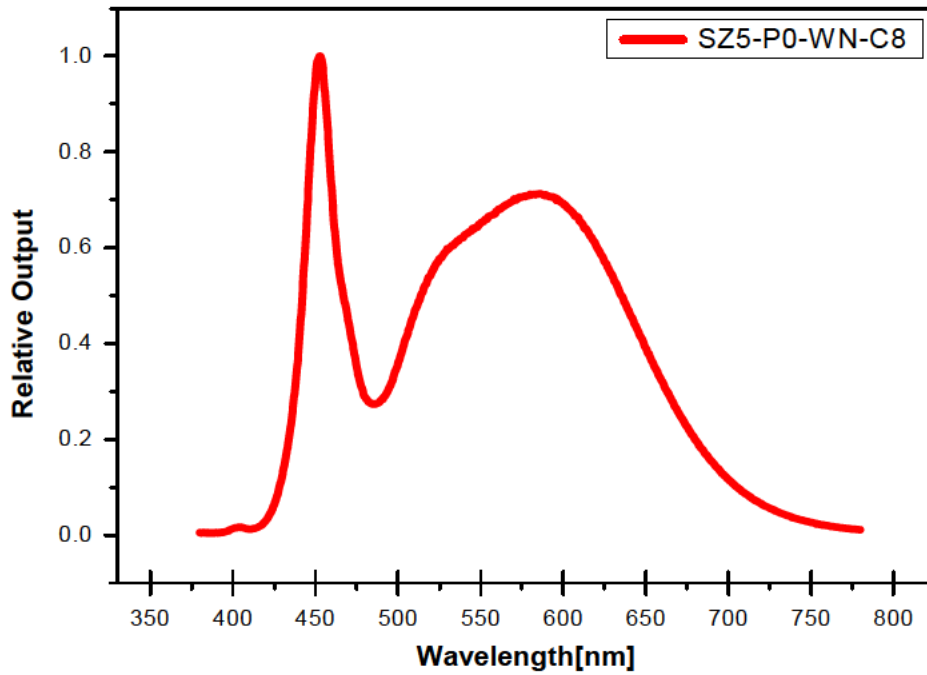
[5] A zener diode is included to protect the product from ESD.

[6] Tolerance is ±2.0 on CRI measurements

## 4. Characteristic diagrams

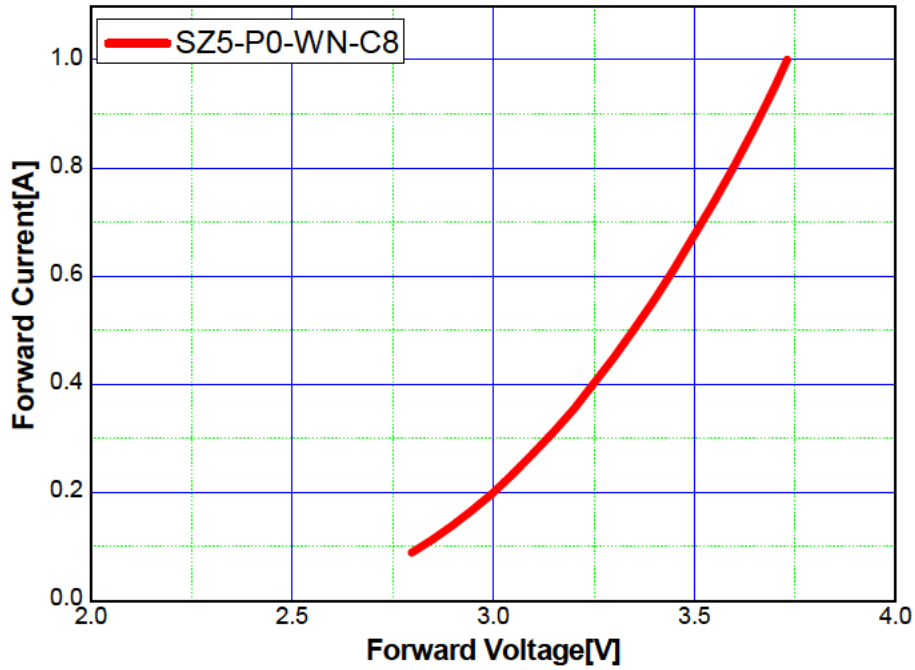
### Color Spectrum

(IF=350mA, Ta=25°C, RH30%)

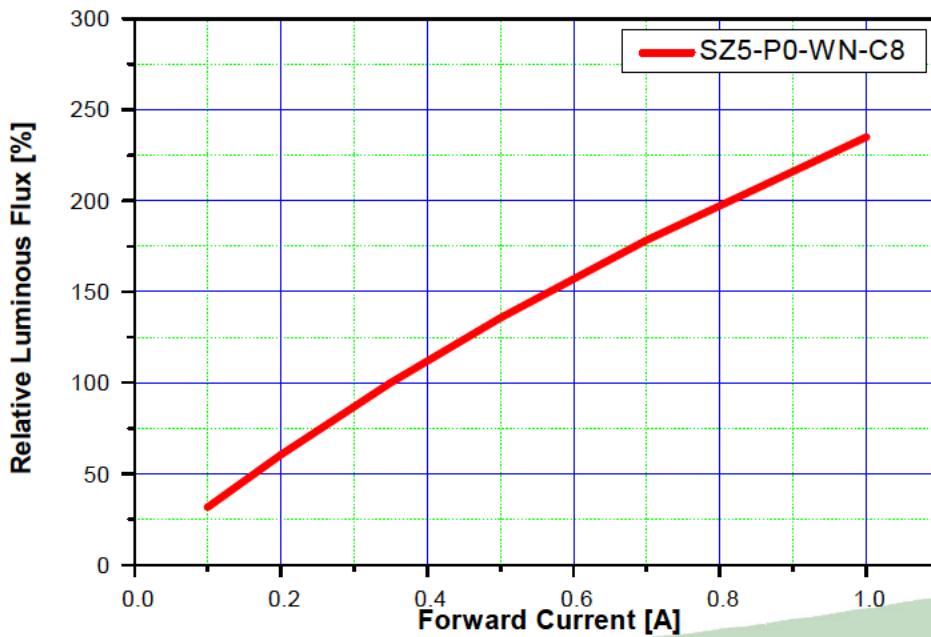


## Forward Current Characteristics

Forward Current vs. Forward Voltage, Ta=25°C



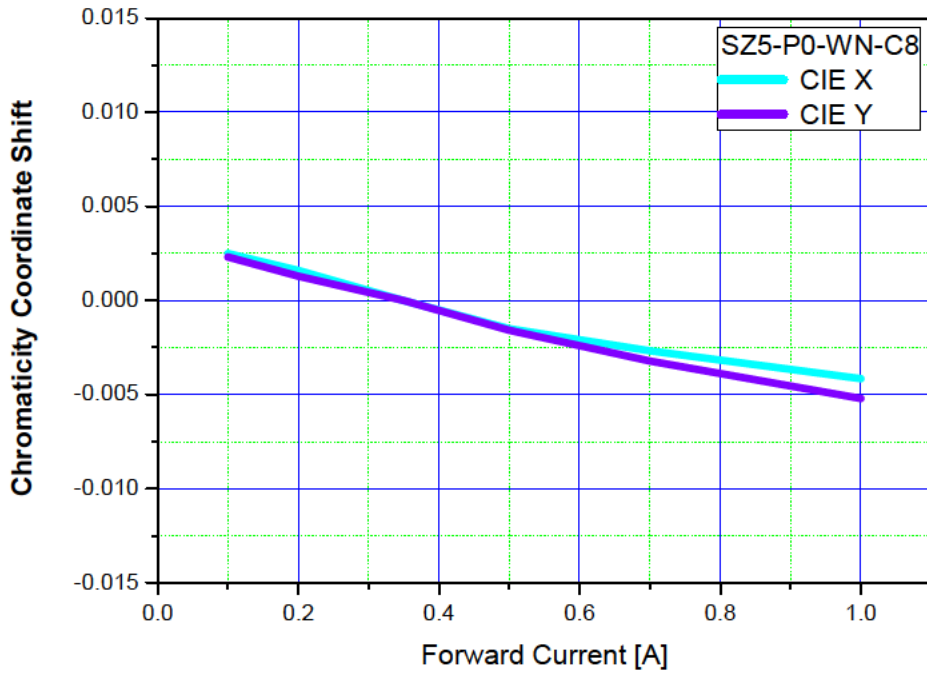
Forward Current vs. Normalized Relative Luminous Flux, Ta=25°C



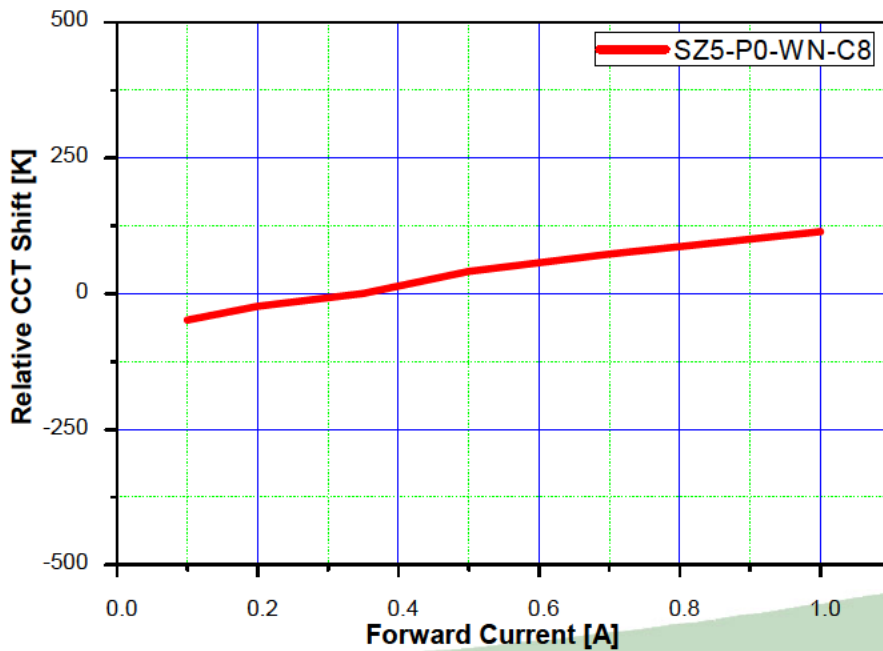


## Forward Current Characteristics

Forward Current vs. Chromaticity Coordinate, Ta=25°C

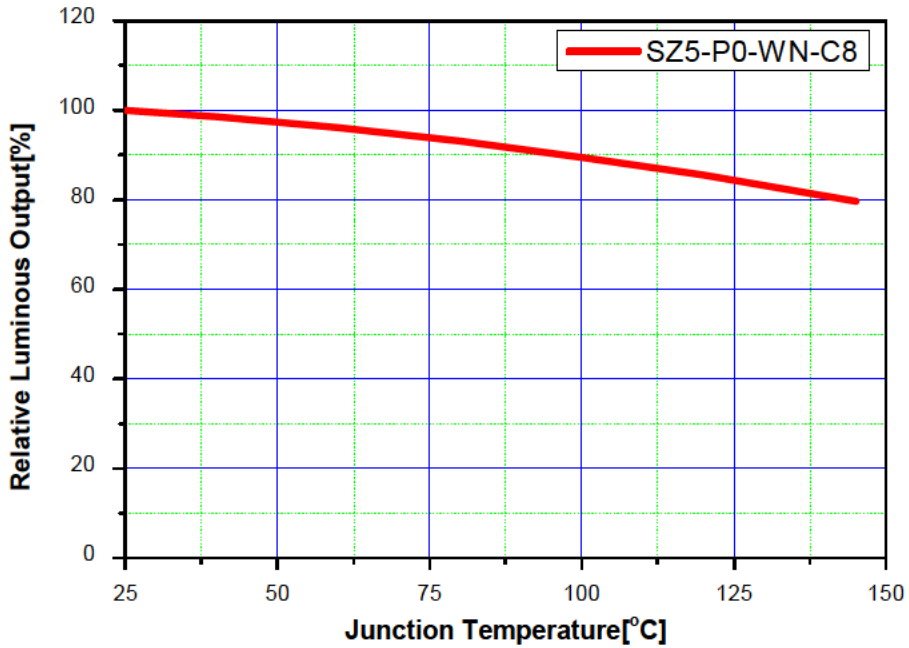


Forward Current vs. CCT, Ta=25°C

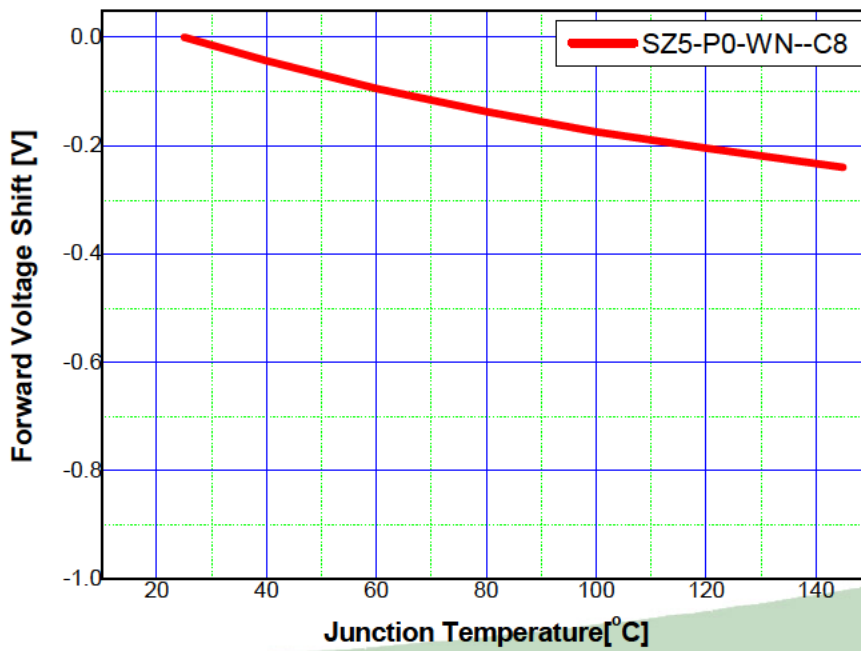


## Junction Temperature Characteristics

**Junction Temperature vs. Relative Light Output at IF=350mA**

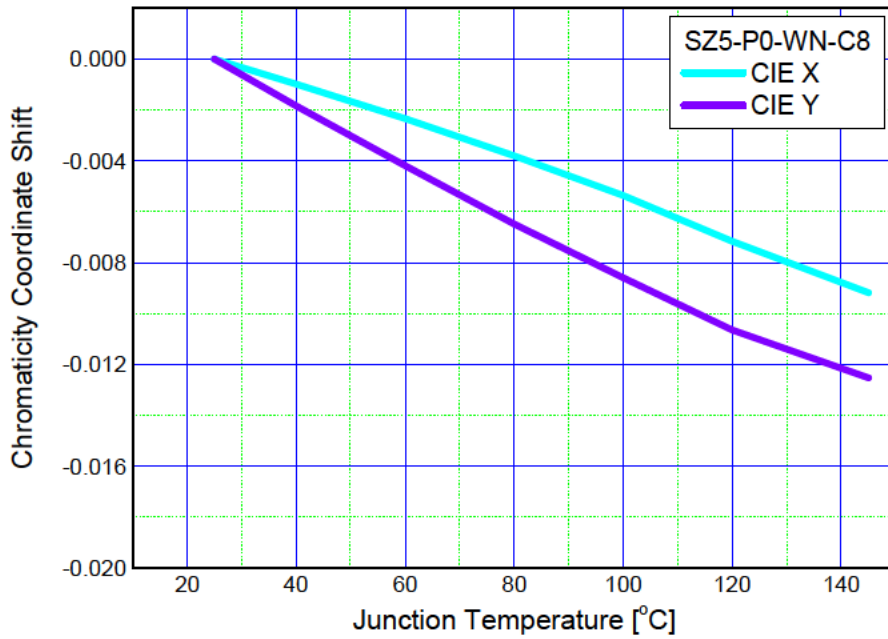


**Junction Temperature vs. Forward Voltage at IF=350mA**

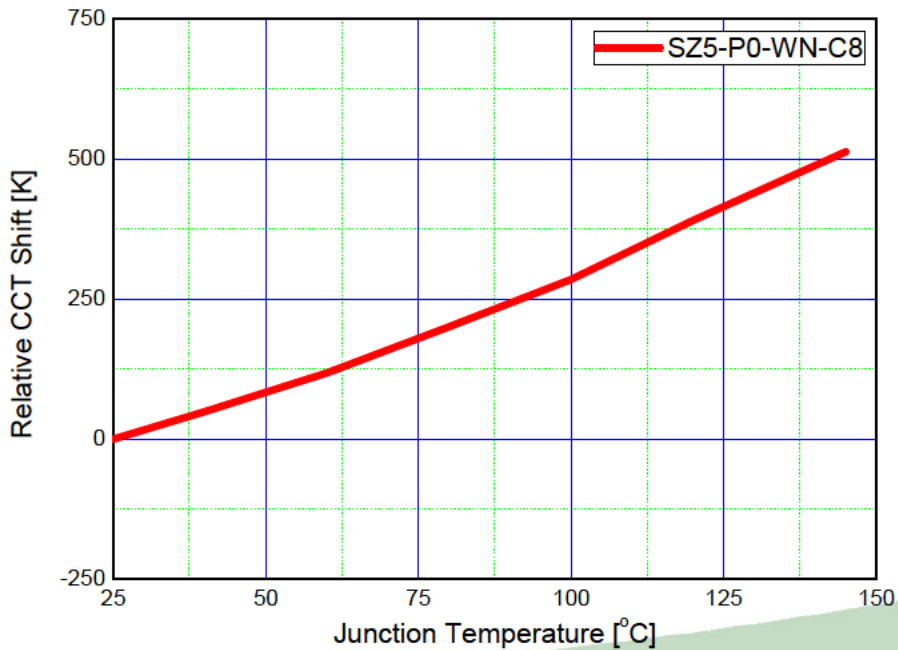


## Junction Temperature Characteristics

### Junction Temperature vs. Chromaticity Coordinate at IF=350mA

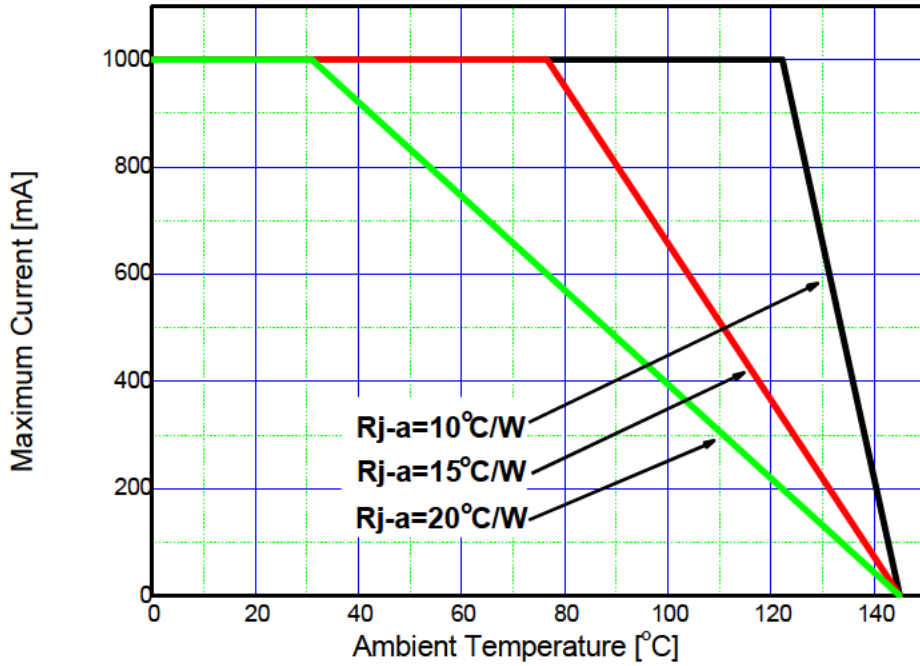


### CCT vs. Junction Temperature at IF=350mA

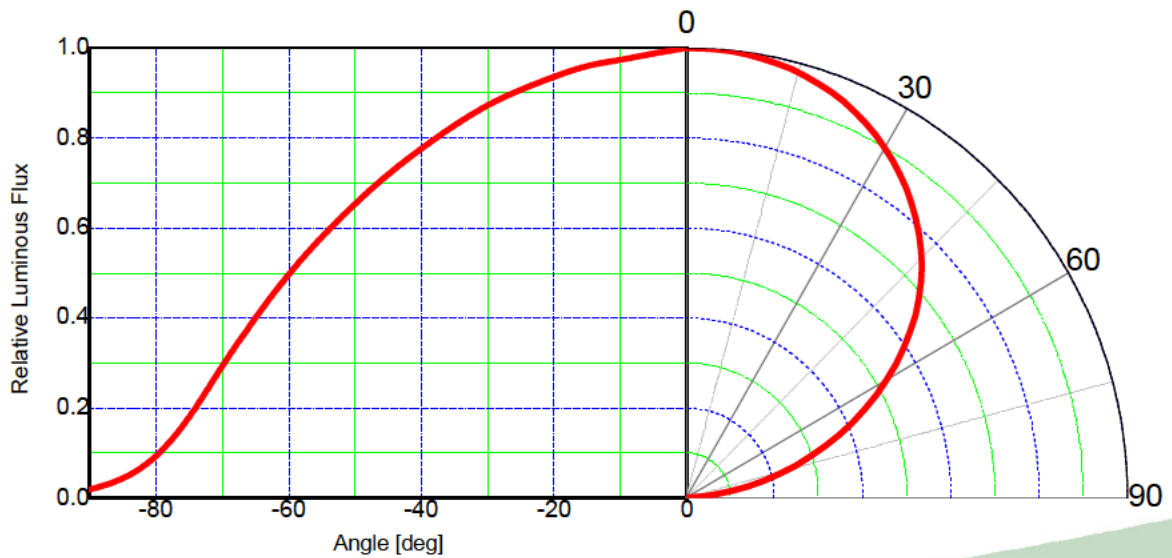


**Characteristic diagrams**

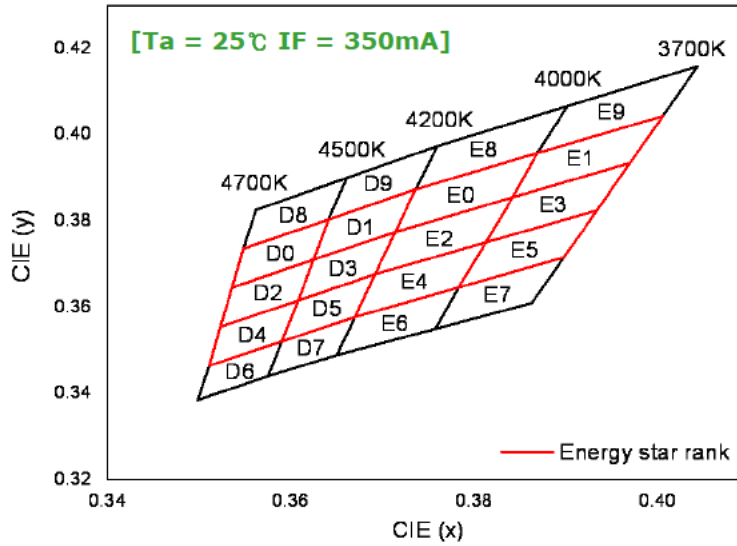
**Ambient Temperature vs. Allowable Forward Current (Tjmax = 145°C, @1.0A)**



**Radiation pattern at 350mA**



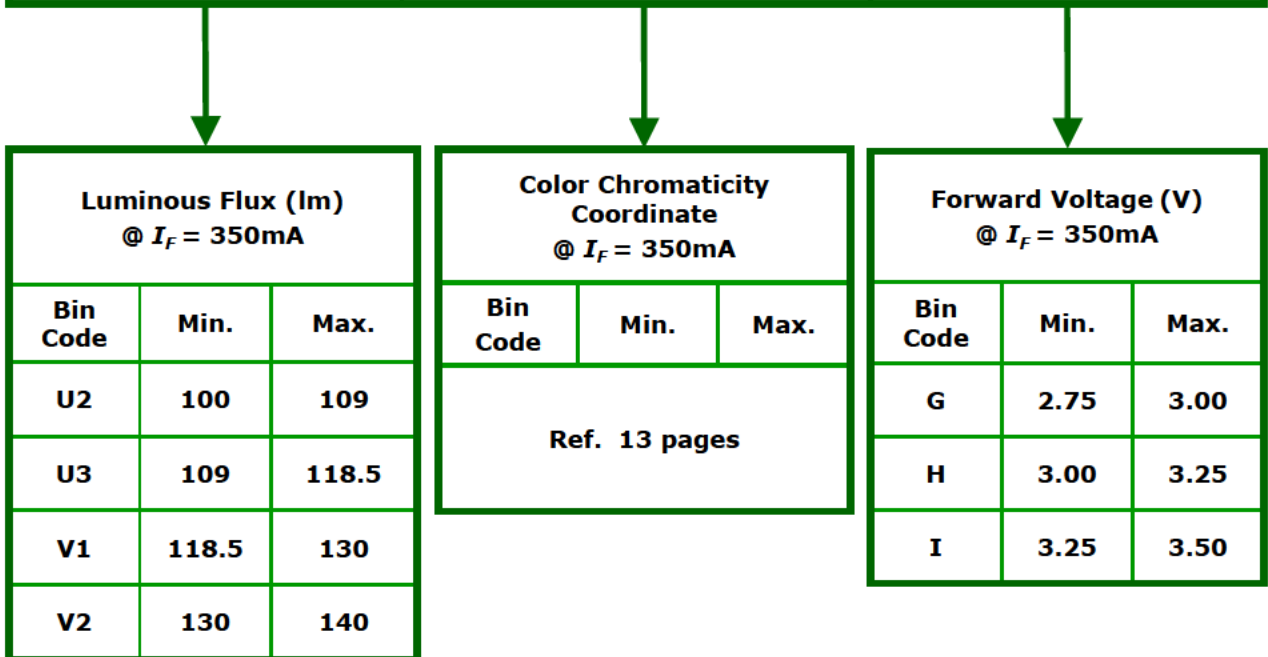
## 5. CIE Chromaticity Diagram (Neutral)



| D8     |        | D0     |        | D2     |        | D4     |        | D6     |        |
|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  |
| 0.3562 | 0.3826 | 0.3548 | 0.3736 | 0.3536 | 0.3646 | 0.3523 | 0.3555 | 0.3511 | 0.3465 |
| 0.3548 | 0.3736 | 0.3536 | 0.3646 | 0.3523 | 0.3555 | 0.3511 | 0.3465 | 0.3498 | 0.3385 |
| 0.3641 | 0.3804 | 0.3625 | 0.3711 | 0.3608 | 0.3616 | 0.3590 | 0.3521 | 0.3575 | 0.3441 |
| 0.3661 | 0.3900 | 0.3641 | 0.3804 | 0.3625 | 0.3711 | 0.3608 | 0.3616 | 0.3590 | 0.3521 |
| D9     |        | D1     |        | D3     |        | D5     |        | D7     |        |
| CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  |
| 0.3661 | 0.3900 | 0.3641 | 0.3804 | 0.3625 | 0.3711 | 0.3608 | 0.3616 | 0.3590 | 0.3521 |
| 0.3641 | 0.3804 | 0.3625 | 0.3711 | 0.3608 | 0.3616 | 0.3590 | 0.3521 | 0.3575 | 0.3441 |
| 0.3736 | 0.3874 | 0.3714 | 0.3775 | 0.3692 | 0.3677 | 0.3670 | 0.3578 | 0.3650 | 0.3489 |
| 0.3760 | 0.3974 | 0.3736 | 0.3874 | 0.3714 | 0.3775 | 0.3692 | 0.3677 | 0.3670 | 0.3578 |
| E8     |        | E0     |        | E2     |        | E4     |        | E6     |        |
| CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  |
| 0.3760 | 0.3974 | 0.3736 | 0.3874 | 0.3714 | 0.3775 | 0.3692 | 0.3677 | 0.3670 | 0.3578 |
| 0.3736 | 0.3874 | 0.3714 | 0.3775 | 0.3692 | 0.3677 | 0.3670 | 0.3578 | 0.3650 | 0.3489 |
| 0.3869 | 0.3958 | 0.3842 | 0.3855 | 0.3813 | 0.3751 | 0.3783 | 0.3646 | 0.3758 | 0.3550 |
| 0.3902 | 0.4067 | 0.3869 | 0.3958 | 0.3842 | 0.3855 | 0.3813 | 0.3751 | 0.3783 | 0.3646 |
| E9     |        | E1     |        | E3     |        | E5     |        | E7     |        |
| CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  | CIE x  | CIE y  |
| 0.3902 | 0.4067 | 0.3869 | 0.3958 | 0.3842 | 0.3855 | 0.3813 | 0.3751 | 0.3783 | 0.3646 |
| 0.3869 | 0.3958 | 0.3842 | 0.3855 | 0.3813 | 0.3751 | 0.3783 | 0.3646 | 0.3758 | 0.3550 |
| 0.4006 | 0.4044 | 0.3970 | 0.3935 | 0.3934 | 0.3825 | 0.3898 | 0.3716 | 0.3863 | 0.3610 |
| 0.4044 | 0.4160 | 0.4006 | 0.4044 | 0.3970 | 0.3935 | 0.3934 | 0.3825 | 0.3898 | 0.3716 |

## 6. Bin Code Description

| Bin Code                                     |  |   |
|--|--|---|
| Luminous Flux (lm)<br>@ $I_F = 350\text{mA}$ | Color Chromaticity<br>Coordinate<br>@ $I_F = 350\text{mA}$ | Forward Voltage (V)<br>@ $I_F = 350\text{mA}$ |
| V1   | E2   | H   |



| Luminous Flux (lm)<br>@ $I_F = 350\text{mA}$ |       |       |  |
|--|-------|-------|--|
| Bin Code                                     | Min.  | Max.  |  |
| U2   | 100   | 109   |  |
| U3   | 109   | 118.5 |  |
| V1   | 118.5 | 130   |  |
| V2   | 130   | 140   |  |

| Color Chromaticity<br>Coordinate<br>@ $I_F = 350\text{mA}$ |      |      |  |
|--|------|------|--|
| Bin Code   | Min. | Max. |  |
| Ref. 13 pages  |      |      |  |

| Forward Voltage (V)<br>@ $I_F = 350\text{mA}$ |      |      |  |
|---|------|------|--|
| Bin Code                                      | Min. | Max. |  |
| G   | 2.75 | 3.00 |  |
| H   | 3.00 | 3.25 |  |
| I   | 3.25 | 3.50 |  |

## 7. Labeling

|                                |                            |
|--------------------------------|----------------------------|
| Rank :                         | $X_{10}X_{11}X_{12}X_{13}$ |
|                                |                            |
| Quantity : 1000                |                            |
|                                |                            |
| Lot No : #####                 |                            |
|                                |                            |
| SSC PART NUMBER : SZ5-P0-WN-C8 |                            |
|                                |                            |
| SZ5-P0-WN-C8                   |                            |

### Full code form

$X_1X_2X_3 - X_4X_5 - X_6X_7 - X_8X_9$

- $X_1$  : Company
- $X_2 X_3$  : Z-Power LED series number
- $X_4$  : PKG series
- $X_5$  : Revision No.
- $X_6X_7$  : Color
- $X_8X_9$  : CRI Group

### Rank

$X_{10}X_{11}X_{12}X_{13}$

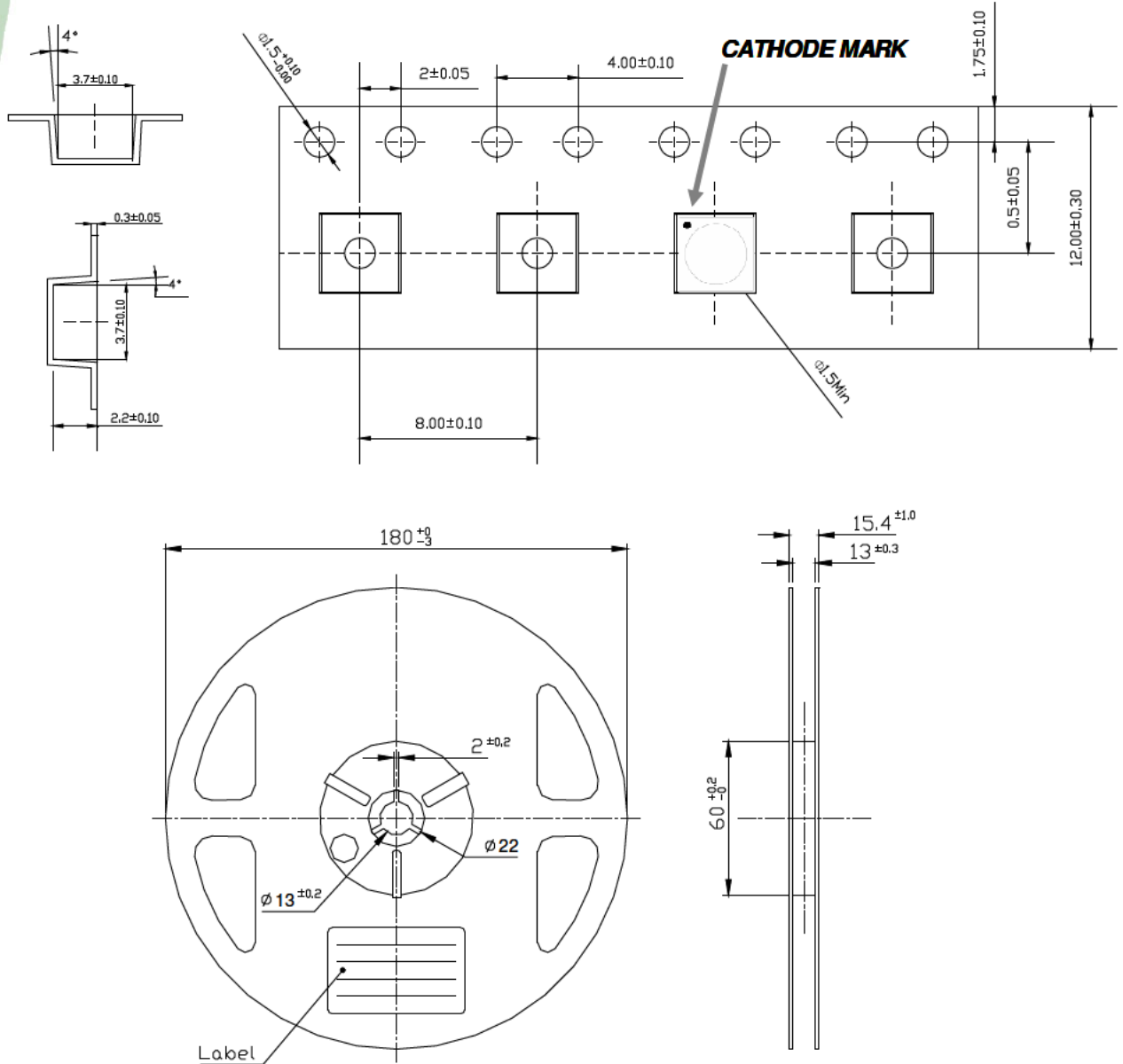
- $X_{10}$  : Luminous Flux : LF [lm]
- $X_{11}X_{12}$  : Color coordinates : x, y
- $X_{13}$  : Forward Voltage :  $V_F$  [V]

### Lot No

$\#1\#2\#3\#4\#5\#6 - \#7\#8\#9\#10 - \#11\#12\#13$

- |                     |                                   |
|---------------------|-----------------------------------|
| - $\#1 \#2$ : Year  | - $\#7 \#8 \#9 \#10$ : Mass order |
| - $\#3 \#4$ : Month | - $\#11 \#12 \#13$ : Tray No.     |
| - $\#5 \#6$ : Day   |                                   |

## 8. Packing



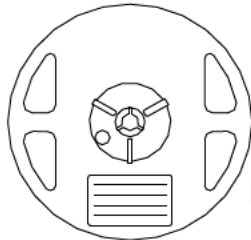
- (1) Quantity : 1000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2\text{mm}$
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 10-60g when the cover tape is turned off from the carrier tape at the angle of  $10^\circ$  to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package



## 8. Packing

### ● Reel Packing Structure

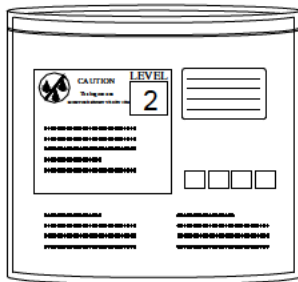
#### Reel



Rank : **X<sub>10</sub>X<sub>11</sub>X<sub>12</sub>X<sub>13</sub>**  
 Quantity : 1000  
 Lot No : #####  
 SSC PART NUMBER : SZ5-P0-WN-C8  
**SEOUL SZ5-P0-WN-C8**



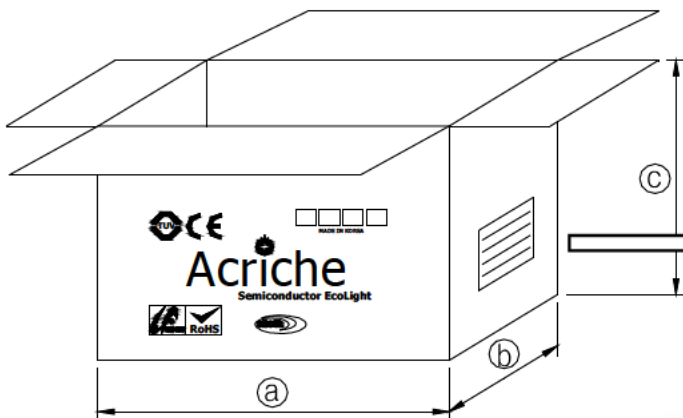
#### Aluminum Vinyl Bag



Rank : **X<sub>10</sub>X<sub>11</sub>X<sub>12</sub>X<sub>13</sub>**  
 Quantity : 1000  
 Lot No : #####  
 SSC PART NUMBER : SZ5-P0-WN-C8  
**SEOUL SZ5-P0-WN-C8**



#### Outer Box

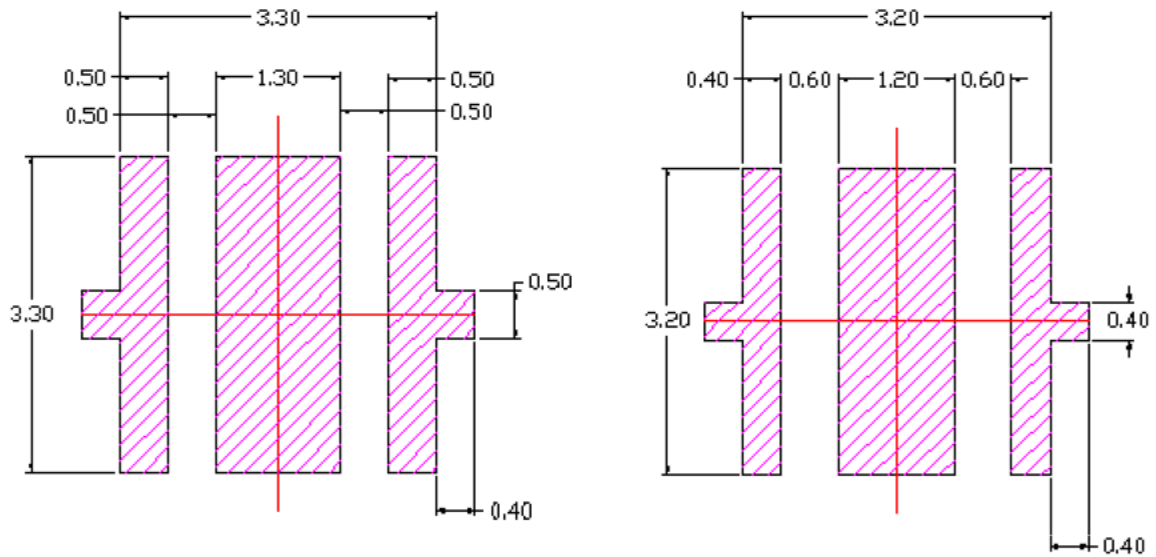


\*Material : Paper (SW3B(B))

| TYPE   | SIZE (mm) |     |     |
|--------|-----------|-----|-----|
|        | Ⓐ         | Ⓑ   | Ⓒ   |
| 7 inch | 245       | 220 | 142 |

**Z LED**  
 PART : \*\*\*\*\*  
 CODE : \*\*\*\*\*  
 Q'YT : \*\*\*\*\*  
 LOT NO : \*\*\*\*\*  
 DATE : \*\*\*\*\*  
**SEOUL SEMICONDUCTOR CO.,LTD**

## 9. Recommended solder pad



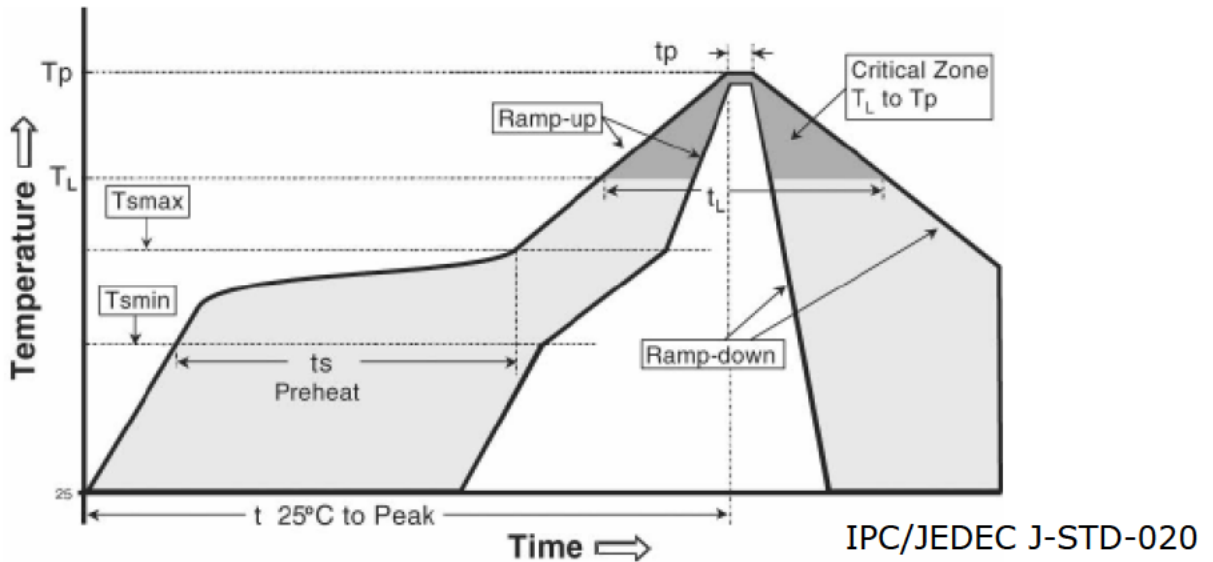
Recommended PCB Solder Pad

Recommended Stencil Pattern

**Notes :**

- [1] All dimensions are in millimeters.
- [2] Scale : none
- [3] This drawing without tolerances are for reference only
- [4] Undefined tolerance is  $\pm 0.1\text{mm}$

## 10. Soldering



| Profile Feature  | Sn-Pb Eutectic Assembly            | Pb-Free Assembly                   |
|--|------------------------------------|------------------------------------|
| <b>Average ramp-up rate (Tsmmax to Tp)</b>   | 3° C/second max.                   | 3° C/second max.                   |
| <b>Preheat</b><br>- Temperature Min (Tsmmin)<br>- Temperature Max (Tsmmax)<br>- Time (Tsmmin to Tsmmax) (ts) | 100 °C<br>150 °C<br>60-120 seconds | 150 °C<br>200 °C<br>60-180 seconds |
| Time maintained above:<br>- Temperature (TL)<br>- Time (tL)  | 183 °C<br>60-150 seconds           | 217 °C<br>60-150 seconds           |
| Peak Temperature (Tp)  | 215°C                              | 260°C                              |
| Time within 5°C of actual Peak Temperature (tp)2   | 10-30 seconds                      | 20-40 seconds                      |
| Ramp-down Rate   | 6 °C/second max.                   | 6 °C/second max.                   |
| Time 25°C to Peak Temperature  | 6 minutes max.                     | 8 minutes max.                     |

**\* Caution**

1. Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
2. Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
3. Die slug is to be soldered.
4. When soldering, do not put stress on the LEDs during heating.
5. After soldering, do not warp the circuit board.

## 11. Precaution for use

### (1) Storage

To avoid the moisture penetration, we recommend storing Z5P Series (Z Power) LEDs in a dry box with a desiccant . The recommended storage temperature range is 5℃ to 30℃ and a maximum humidity of RH50%.

### (2) Use Precaution after Opening the Packaging

Use proper SMD techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency. Pay attention to the following:

#### a. Recommend conditions after opening the package

- Sealing

- Temperature : 5 ~ 40℃ Humidity : less than RH30%

#### b. If the package has been opened more than 1 year (MSL 2) or the color of the desiccant changes, components should be dried for 10-12hr at 60±5℃

(3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.

(4) Do not rapidly cool device after soldering.

(5) Components should not be mounted on warped (non coplanar) portion of PCB.

(6) Radioactive exposure is not considered for the products listed here in.

(7) Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or shredded in the process of disposal. It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.

(8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.

(9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.

(10) LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.

(11) The appearance and specifications of the product may be modified for improvement without notice.

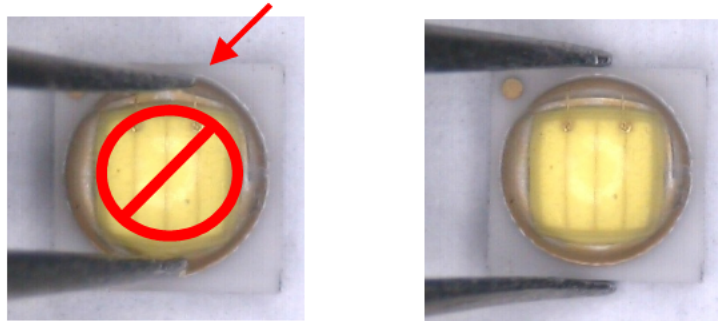
(12) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.

## 11. Precaution for use

- (13) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.
- (14) The slug is isolated from anode electrically.  
Therefore, we recommend that you don't isolate the heat sink.
- (15) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (16) The driving circuit must be designed to allow forward voltage only when it is ON or OFF.  
If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.

## 12. Handling of Silicone Resin LEDs

- (1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



- (2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.
- (3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.
- (4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust. As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.
- (5) SSC suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.
- (6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this product with acid or sulfur material in sealed space.
- (7) Avoid leaving fingerprints on silicone resin parts.